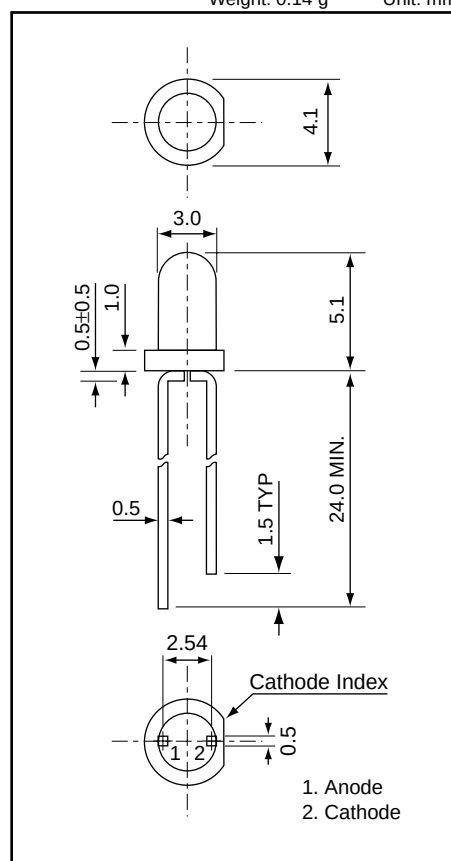




Weight: 0.14 g Unit: mm



AND262GCP

GaP Green Light Emission

T-1 Package (3 mm)

Features

- High efficient green LED
- Peak wavelength ($\lambda_p = 567$ nm) high bright emission
- All plastic mold type, clear colorless lens
- Low drive current: 10 to 20 mA recommended
- Excellent On-Off contrast ratio
- Fast response time, capable of pulse operation

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Forward Current	I_F	30	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P_D	75	mW
Operating Temperature Range	T_{Opr}	-25 to 85	$^\circ\text{C}$
Storage Temperature Range	T_{Stg}	-25 to 85	$^\circ\text{C}$

Electro-Optical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V_F	$I_F = 20$ mA	—	2.2	2.6	V
Reverse Current	I_R	$V_R = 4$ V	—	—	50	μA
Luminous Intensity	I_V	$I_F = 20$ mA	70	110	—	mcd
Peak Emission Wavelength	I_P	$I_F = 20$ mA	—	567	—	nm
Spectral Line Half Width	$\Delta\lambda$	$I_F = 20$ mA	—	25	—	nm
Dominant Wavelength	λ_d	$I_F = 20$ mA	—	563	—	nm
Full Viewing Angle	θ	$I_V = 1/2$ Peak	—	36	—	degree

Precaution

Please be careful of the following:

1. Soldering temperature: 260°C max
Soldering time: 5 sec. max
Soldering portion of lead: up to 1.6 mm from the body of the device
2. The lead can be formed up to 5 mm from the body of the device without forming stress.
Soldering should be performed after the lead forming.

